

# CHENMKO ENTERPRISE CO., LTD

## SURFACE MOUNT

SCHOTTKY BARRIER RECTIFIER VOLTAGE RANGE 20 Volts CURRENT 2.0 Amperes

# www.DataSho

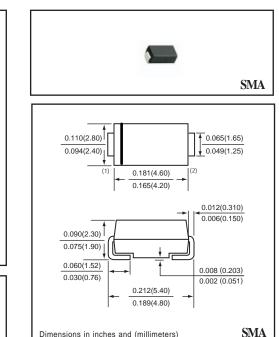
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0 For surface mounted applications Low profile package
- Built-in strain relief
- Metal silicon junction, majority carrier conduction
- Low power loss, high efficiency
- High current capability, low forward voltage drop
- High surge capability
- For use in low voltage high frequency inverters, free wheeling, and polarity protection applications
- High temperature soldering guaranteed :
- 260°C/10 seconds at terminals

### \* Low VF Products **MECHANICAL DATA**

Case: JEDEC SMA molded plastic Terminals: Solder plated, solderable per MIL-STD-750, Method 2026 Polarity: Color band denotes cathode end Weight: 0.002 ounce 0.064 gram

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.



Dimensions in inches and (millimeters)

### MAXIMUM RATINGES ( At TA = 25°C unless otherwise noted )

RATINGS	SYMBOL	SSM22LLPT	UNITS
Maximum Recurrent Peak Reverse Voltage	Vrrm	20	Volts
Maximum RMS Voltage	VRMS	14	Volts
Maximum DC Blocking Voltage	VDC	20	Volts
Maximum Average Forward Rectified Current	lo	2.0	Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	IFSM	50	Amps
Typical Junction Capacitance (Note 2)	CJ	210	pF
Typical Thermal Resistance (Note 1)	RθJL	20	°C/W
Operating Temperature Range	TJ	-65 to +125	°C
Storage Temperature Range	Тѕтс	-65 to +150	°C

### ELECTRICAL CHARACTERISTICS ( At TA = 25°C unless otherwise noted )

CHARACTERISTICS		SYMBOL	SSM22LLPT	UNITS
Maximum Instantaneous Forward Voltage at 2.0 A DC		VF	0.27	Volts
Maximum Average Reverse Current	@ TA = 25°C	· Ir	0.5	mAmps
at Rated DC Blocking Voltage	@ TA = 100°C		10	mAmps
NOTES 1 Thermal Resistance ( Junction to Lead ) - PC Roard Mounted on 0.2 X 0.2" ( 5 X 5mm ) conner nad area				2001-6

NOTES: 1. Thermal Resistance ( Junction to Lead ) : PC Board Mounted on 0.2 X 0.2" ( 5 X 5mm ) copper pad area. 2. Measured at 1.0 MHz and applied reverse voltage of 4.0 volts.

SSM22LLPT

